

Basic information	
<p>2013/2918(DEA)</p> <p>DEA - Delegated acts procedure</p> <p>Exemption for lead in solders, termination coatings of electrical and electronic components and printed circuit boards, connections of electrical wires, shields and enclosed connectors</p> <p>Supplementing 2008/0240(COD)</p> <p>Subject</p> <p>3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)</p>	<p>Procedure completed - delegated act enters into force</p>

Technical information	
Procedure reference	2013/2918(DEA)
Procedure type	DEA - Delegated acts procedure
Procedure subtype	Examination of delegated act
	Supplementing 2008/0240(COD)
Stage reached in procedure	Procedure completed - delegated act enters into force
Committee dossier	ENVI/7/14385